



## Redux® 200 series Foaming adhesive films

### Product Data

#### Description

The Redux 200 series is a range of foaming adhesive films presented in sheet form. They expand during the cure cycle to fill gaps and adhere strongly to all parts of the structure with which they come into contact.

Redux foaming adhesive films are compatible with Redux film adhesives as follows:-

Foaming Adhesive Films	Application	Cure Temperature °F	Associated Film Adhesives
Redux 206-NA Redux 212-NA	High foaming ratio Low foaming ratio. Suitable for vacuum and non vacuum cure	250	Redux 312, 335, 382H, 609, 610
Redux 208/4-NA Redux 208/5-NA	Suitable with vacuum Higher foaming ratio. Suitable for applications not requiring vacuum	350	Redux 308, 308A-NA
Redux 219/2-NA Redux 219/3-NA	Suitable for thin sections Low exotherm for thicker sections	350	Redux 319, 322, 330, 340(SP), 641

#### Features

- High strength at temperatures from -67°F to 428°F.
- Less than 1% volatiles emitted during cure.
- Suitable for aluminum and fiber-reinforced composite sandwich constructions.
- Expansion ratios from 1:1.9 to 1:4.0

#### Applications

- Joining honeycomb core sections.
- Bonding of honeycomb core to edge members.
- Bonding inserts into sandwich structures.

#### Form

Dry flexible films of dimensions 49" x 8", and with a standard thickness of 0.06", lined on both sides with protective covers. A standard pack contains 8 sheets of the above dimensions.



# Redux 200 series

## Instructions for Use

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### Pretreatment

It is essential that all substrates to be used are free of contamination and in as ideal a state for bonding as possible. As pretreatment will significantly vary dependent on substrates being used, please refer to the Hexcel publication Redux Bonding Technology for optimum procedures.

If there will be a delay between pretreatment and bonding of aluminium, the pretreated surface can be protected with Redux 112 to conserve the good bonding surface. Bonding can be delayed for up to 2 months without deterioration of the pretreated surface.

### Application

1. Allow sufficient time for the adhesive to warm to room temperature (59° to 80°F) before removing the sealed packaging.
2. Cut the film to the shape and size required.
3. Remove the release paper and position the adhesive on the prepared bonding surface.
4. Remove the polythene backing sheet.
5. Complete the joint assembly and apply pressure, at 20.3 - 50 psi, while the adhesive is being cured. For sandwich structures the pressure application should be selected to suit the type of core and skins being used. After the adhesive has cured it is advisable to maintain pressure on the bonded assembly until it has cooled sufficiently to be handled without discomfort.

When inserting the cut film (single layers recommended) between the core and the inner face of each edge member as assembly of the panel proceeds, do not try to push the film into place after the pieces have been positioned. Spring the core segments and other panel components tightly together so that the film is held firmly in place and cannot sag as it is heated. Complete the panel assembly as quickly as possible to minimize the risk of it being disturbed, and apply clamps or other suitable means of restraint to prevent relative movement of the parts either before or during the cure cycle.

### Curing

The recommended cure cycles are:

Adhesive	Cure Cycle
Redux 206-NA Redux 212-NA	60 minutes at 250°F± 5; heat up rate 10°F/min
Redux 208/4-NA Redux 208/5-NA Redux 219/2-NA Redux 219/3-NA	60 minutes at 350°F± 5; heat up rate 10°F/min

Variations from this cure cycle are possible and further information may be obtained from Hexcel on request.

When an autoclave is being used to bond assemblies containing Redux foaming films or any assembly containing unvented honeycomb core, it is recommended that the vacuum line should be opened to atmosphere before heat-up is commenced, and should be left open throughout the cycle. This will ensure more even expansion of the foam. When heating the assembly to curing temperature allow adequate time for heat to penetrate the whole assembly so that the adhesive is properly cured throughout the depth of the panel.

## Performance Data

Following the recommended cure cycles as detailed above, the following typical performance data have been obtained. These results are for guidance only, they do not constitute specification minima for this product.

Product Adhesive	Expansion ratio	Vertical flow	Aluminum double lap shear (0.06" gap)				
			72°F	176°F	212°F	248°F	300°F
Redux 206-NA	1: 4.0	-	536 psi	290 psi			
Redux 212-NA	1: 2.0	-	1232 psi		725 psi		
Redux 208/4-NA	1: 2.0	<0.04	1595 psi			580 psi	
Redux 208/5-NA	1: 2.2	<0.04	1450 psi			652 psi	
Redux 219/2-NA	1: 2.0	<0.04	1305 psi				652 psi
Redux 219/3-NA	1: 1.9	<0.04	1450 psi				870 psi

## Handling Precautions

When used properly Redux Foaming Adhesive Films present a low risk of handling hazard for the following reasons:

- Film may be cut to shape with release paper covers in place avoiding contact with the bare film.
- The film is virtually tack free and volatile free at temperatures below 72°F.
- There are no problems with splashing, leaking or spillage from the film.

However, the usual precautions when handling synthetic resins should be observed and the use of clean polythene gloves is particularly recommended when handling film adhesives and pretreated components.

A Material Safety Data Sheet for each product in the Redux 200 Series is available on request.

## Storage

It is recommended to store Redux Foam adhesives at 0°F. At this temperature their shelf life will be 18 months. The maximum permissible outlife at 65 - 80°F is 1 - 3 months depending on the product.

The film must be stored in a sealed polythene bag to protect against atmospheric moisture absorption and when removing from cold storage the package must be allowed to reach room temperature before breaking the polythene seal.



## **Release Certification**

The Quality System at Hexcel Duxford has been certified to ISO 9001 by Lloyd's Register Quality Assurance, and is approved by the UK Civil Aviation Authority and Ministry of Defence. Certificates of Conformity and Test Reports can be issued for batches of Redux 200 series on request.

## **Important**

All information is believed to be accurate but is given without acceptance of liability. Users should make their own assessment of the suitability of any product for the purposes required. All sales are made subject to our standard terms of sale which include limitations on liability and other important terms.

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